HSF

Speecification
1.Current Rating: 1.5AMP
2.Contact Resistance: 30mΩ max
3.Insulation Resistance: 1000MΩ min
4.Dielectric Withstanding Voltage: 500V R.M.S
5.Temperature Ratinge: -40℃ to +85℃

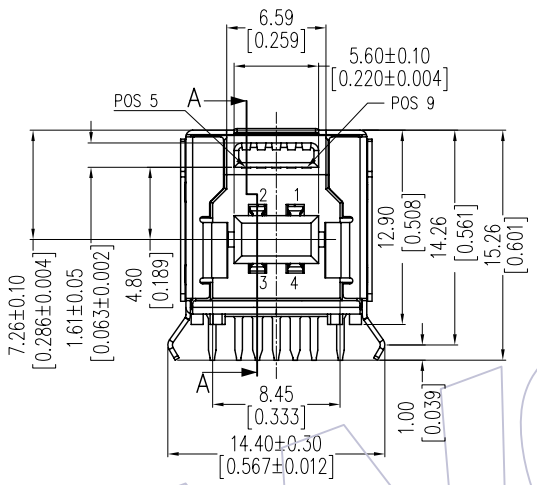
Mechanical Characteristics:
6.Mating Force: 3.57kg.min
7.Mating Force: 1.02kg.min
8.Durability: Mandatory: 5000 Cycles

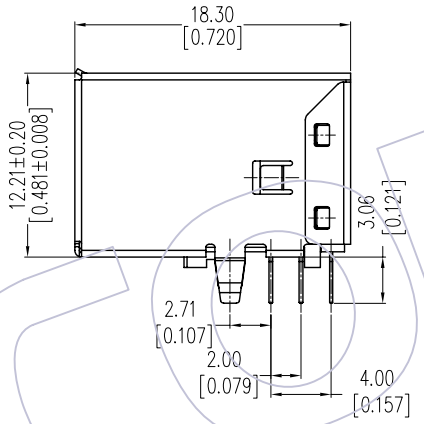
Contact: Copper(5P: T=0.20/4P: T=0.25)
Insulator: LCP+30%GF(UL94V-0)
Shell: Brass(T=0.30mm)

Ordering Information

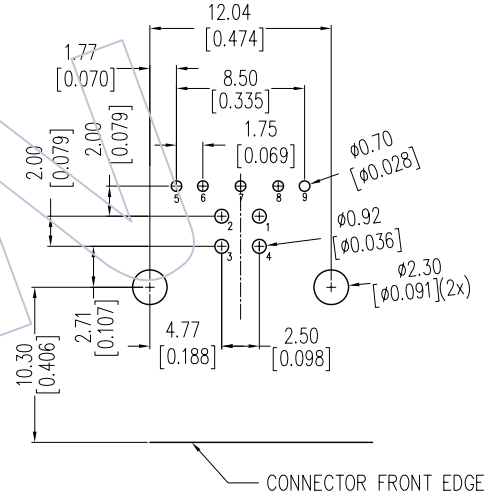
6112-09 B F R D XX U N A2

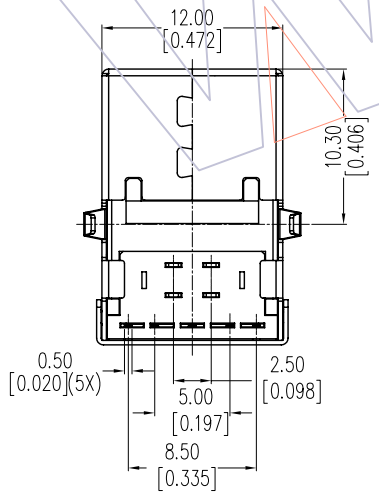
Contact Plating	Plating	Packing:	Series No.
S0=Gold Flash/Tin S1=3u"Gold/Tin S2=5u"Gold/Tin S3=10u"Gold/Tin S4=15u"Gold/Tin S5=30u"Gold/Tin	B=Black W=White U=Blue R=Red	A=Tray	

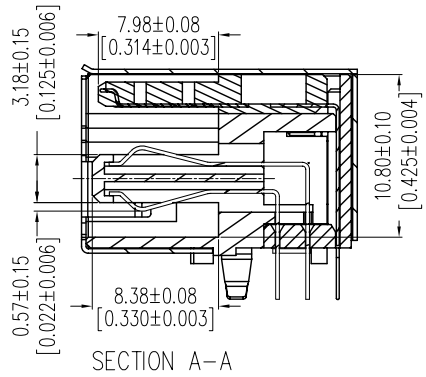




Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)







SECTION A-A

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012/06/30	NEW	——

OPERATION		DRAW	DATE	SCALE	FIT
X.X	±0.40	JYHuang	2012/06/30	UNIT	mm / inch
X.XX	±0.25	CHECK	DATE	SIZE	A4
X.XXX	±0.15			SHEET	1/1
Angle	± 3°	APPROVE	DATE	PROJ.	
DIM	TOL				

PART NO. 6112-09BFRDXXXNA2

TITLE:
USB3.0B-TYPE FEMALE 90°
壳高12.21, H=12.90, 1.0短弯脚DIP

Customer NO.

WCON
Http: www.wcon.com

WCON-Dongguan
Tel: +86 769 85358920
Fax: +86 769 85358915
E-mail: sales@wcon.com

WCON-Kunshan
Tel: +86 512 57468408
Fax: +86 512 57468468
E-mail: salesks@wcon.com